



P-Channel Enhancement-Mode Vertical DMOS Power FETs

Ordering Information

BV_{DSS} / BV_{DGS}	$R_{DS(ON)}$ (max)	$I_{D(ON)}$ (min)	Order Number / Package			
			TO-3	TO-39	TO-220	DICE
-350V	6Ω	-1.5A	VP0335N1	VP0335N2	VP0335N5	VP0335ND
-400V	6Ω	-1.5A	VP0340N1	VP0340N2	VP0340N5	VP0340ND

Features

- Freedom from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- Low C_{iss} and fast switching speeds
- Excellent thermal stability
- Integral Source-Drain diode
- High input impedance and high gain
- Complementary N- and P-Channel devices

Advanced DMOS Technology

These enhancement-mode (normally-off) power transistors utilize a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces devices with the power handling capabilities of bipolar transistors and with the high input impedance and negative temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, these devices are free from thermal runaway and thermally-induced secondary breakdown.

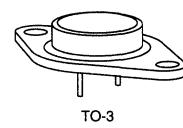
Supertex Vertical DMOS Power FETs are ideally suited to a wide range of switching and amplifying applications where high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

Applications

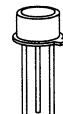
- Motor control
- Convertors
- Amplifiers
- Switches
- Power supply circuits
- Driver (Relays, Hammers, Solenoids, Lamps, Memories, Displays, Bipolar Transistors, etc.)

Package Options

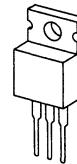
(Notes 1 and 2)



TO-3



TO-39



TO-220

Absolute Maximum Ratings

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	$\pm 20V$
Operating and Storage Temperature	-55°C to +150°C
Soldering Temperature*	300°C

*Distance of 1.6 mm from case for 10 seconds.

Note 1: See Package Outline section for discrete pinouts.
Note 2: See Array section for quad pinouts.

Thermal Characteristics

Package	I_D (continuous)*	I_D (pulsed)*	Power Dissipation @ $T_c = 25^\circ\text{C}$	θ_{jc} °C/W	θ_{ja} °C/W	I_{DR}	I_{DRM}^*
TO-3	-2.7A	-5.0A	100W	1.25	30	-2.7A	-5.0A
TO-39	-0.7A	-5.0A	6W	20.8	125	-0.7A	-5.0A
TO-220	-1.6A	-5.0A	50W	2.5	40	-1.6A	-5.0A

* I_D (continuous) is limited by max rated T_j .

Electrical Characteristics (@ 25°C unless otherwise specified)

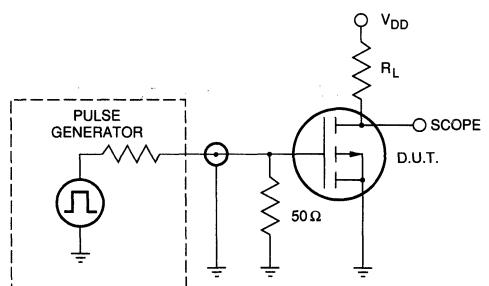
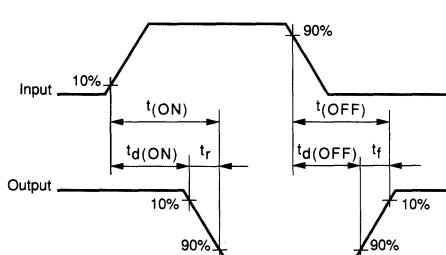
(Notes 1 and 2)

Symbol	Parameter		Min	Typ	Max	Unit	Conditions
BV_{DSS}	Drain-to-Source Breakdown Voltage		VP0340	-400		V	$V_{GS} = 0, I_D = -10\text{mA}$
			VP0335	-350			
$V_{GS(\text{th})}$	Gate Threshold Voltage		-2.5		-4.5	V	$V_{GS} = V_{DS}, I_D = -10\text{mA}$
$\Delta V_{GS(\text{th})}$	Change in $V_{GS(\text{th})}$ with Temperature			-4.8	-6.0	mV/°C	$V_{GS} = V_{DS}, I_D = -10\text{mA}$
I_{GSS}	Gate Body Leakage				-100	nA	$V_{GS} = \pm 20\text{V}, V_{DS} = 0$
I_{DSS}	Zero Gate Voltage Drain Current				-200	μA	$V_{GS} = 0, V_{DS} = \text{Max Rating}$
					-2	mA	$V_{GS} = 0, V_{DS} = 0.8 \text{ Max Rating}$ $T_A = 125^\circ\text{C}$
$I_{D(\text{ON})}$	ON-State Drain Current			-1.5		A	$V_{GS} = -5\text{V}, V_{DS} = -25\text{V}$
				-1.5			$V_{GS} = -10\text{V}, V_{DS} = -25\text{V}$
$R_{DS(\text{ON})}$	Static Drain-to-Source ON-State Resistance			5		Ω	$V_{GS} = -5\text{V}, I_D = -0.25\text{A}$
				4			$V_{GS} = -10\text{V}, I_D = -0.5\text{A}$
$\Delta R_{DS(\text{ON})}$	Change in $R_{DS(\text{ON})}$ with Temperature			0.7	1.2	%/°C	$V_{GS} = -10\text{V}, I_D = -0.5\text{A}$
G_{FS}	Forward Transconductance		0.5	1		Ω	$V_{DS} = -25\text{V}, I_D = -0.5\text{A}$
C_{ISS}	Input Capacitance		550	700			$V_{GS} = 0, V_{DS} = -25\text{V}$ $f = 1 \text{ MHz}$
C_{OSS}	Common Source Output Capacitance		90	120		pF	
C_{RSS}	Reverse Transfer Capacitance		20	50			
$t_{d(\text{ON})}$	Turn-ON Delay Time		25	40			$V_{DD} = -25\text{V}$ $I_D = -1\text{A}$ $R_S = 50\Omega$
t_r	Rise Time		25	40		ns	
$t_{d(\text{OFF})}$	Turn-OFF Delay Time		65	110			
t_f	Fall Time		20	40			
V_{SD}	Diode Forward Voltage Drop		-1	-1.3	V		$V_{GS} = 0, I_{SD} = -0.5\text{A}$
t_{rr}	Reverse Recovery Time		500		ns		$V_{GS} = 0, I_{SD} = -0.5\text{A}$

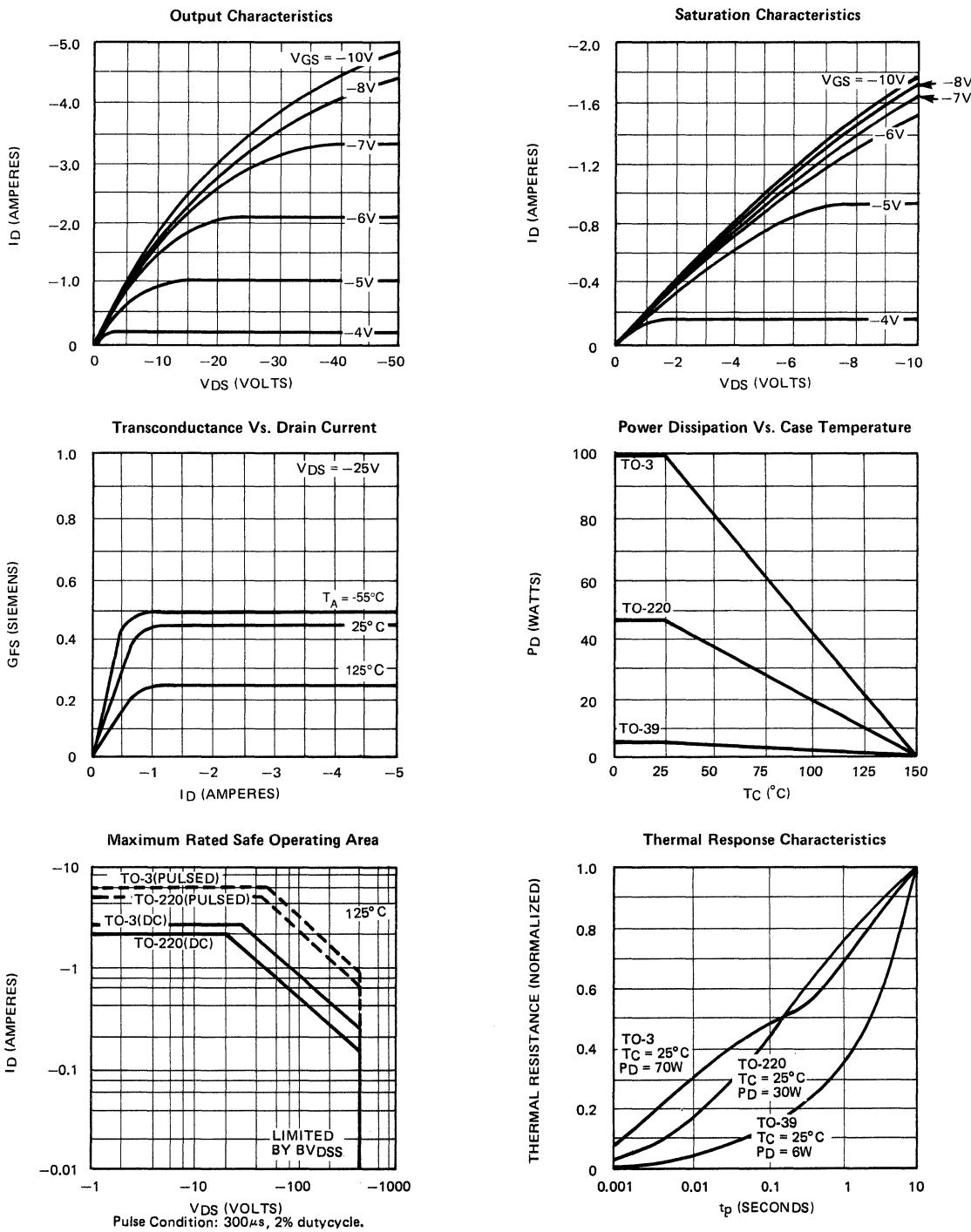
Note 1: All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300μs pulse, 2% duty cycle.)

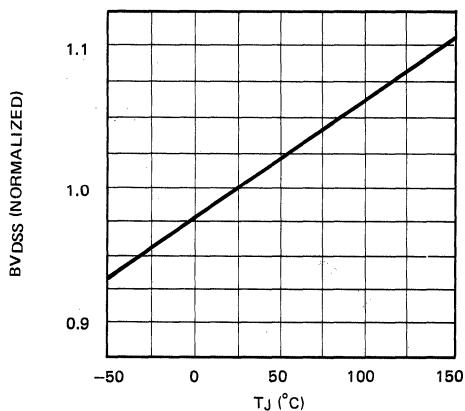
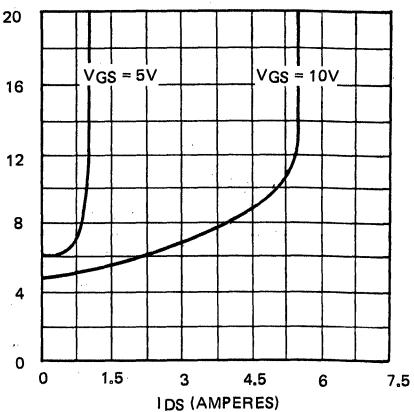
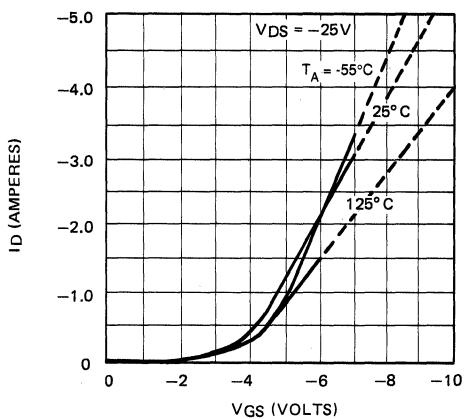
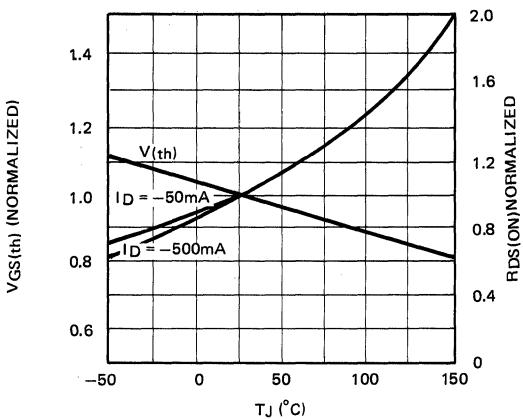
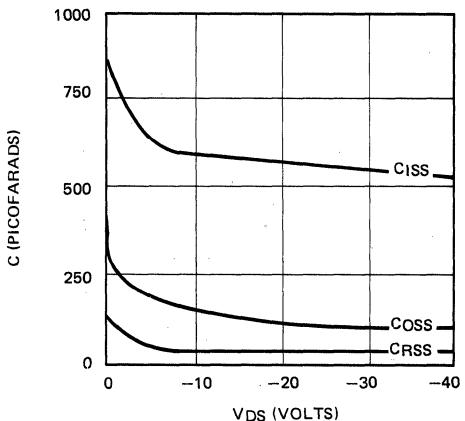
Note 2: All A.C. parameters sample tested.

Switching Waveforms and Test Circuit



Typical Performance Curves



BVDSS Variation with Temperature**ON - Resistance Vs. Drain Current****Transfer Characteristics****V(th) and RDS Variation with Temperature****Capacitance Vs. Drain-to-Source Voltage****Gate Drive Dynamic Characteristics**